

PRODUCT SPECIFICATION

DOCUMENT NO.ENS000134890				
DESCRIPTION	DRAWN BY	DESIGNED BY	CHECKED BY	APPROVED BY
MLVS1210 PDG Series	Sandy	OuBao	Shawn Yeh	Shawn Yeh



MLVS1210 PDG Series Engineering Specification

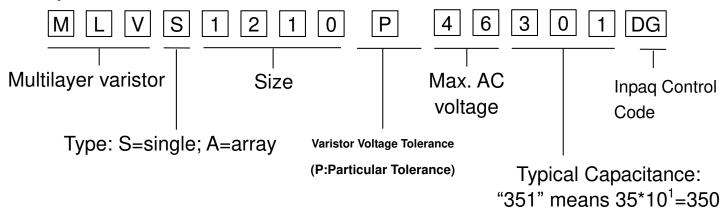
1. Scope

- (1) RoHS compliant
- (2) Meet IEC61000-4-5 standard
- (3) SMD type zinc oxide based ceramic chip
- (4) Insulator over coat keeps excellent low and stable leakage current
- (5) Quick response time (<0.5ns)
- (6) High transient current capability
- (7) High reliability
- (8) Compact size for EIA1210

Applications

Protection against high working voltage applications related transient overvoltage

2. Explanation of Part Number



TITLE: MLVS1210 PDG Series Engineering Specification

В

DOCUMENT NO. ENS000134890

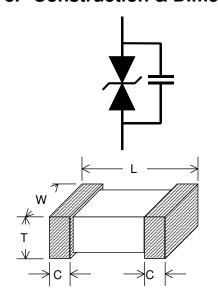
SPEC REV.: A0 Page 1 of 7

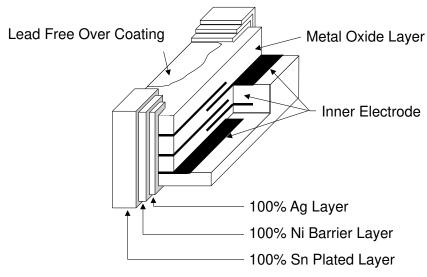
www.inpaq.com.tw; www.inpaqgp.com

I-FM-04-40



3. Construction & Dimension





Unit : mm	1210
L	3.20±0.3
W	2.50±0.25
Т	1.7 max.
С	0.50±0.25

TITLE : MLVS1210 PDG Series Engineering Specification

DOCUMENT NO. ENS000134890

SPEC REV.: A0 Page 2 of 7

www.inpaq.com.tw; www.inpaqgp.com

В



4. Part ratings and characteristics

4.1. Ratings (25°C for characteristics)

	Working voltage		Varistor voltage	Clamping Voltage	Capacitance	Peak current
Symbol	V_{RMS}	V_{DC}	V_{V}	Vc	Ср	i _{max}
Units	Volts	Volts	Volts	Volts	pF	Amps
Units	(Max.)	(Max.)	VOIIS	(Max.)	(Typical)	(Max.)
Test Condition		< 10μΑ	1mA DC	2.5A 8/20μs	1KHz	8/20μs
MLVS1210P04212DG	4	5.5	9~14	28	2100	400
MLVS1210P14112DG	14	18	22~29	45	1100	500
MLVS1210P18601DG	18	26	31~38	60	600	400
MLVS1210P34351DG	34	48	54~67	100	350	300
MLVS1210P46301DG	46	60	69~83	125	300	450
MLVS1210P50211DG	50	65	73~91	135	210	300
MLVS1210P60231DG	60	85	90~110	165	230	400
MLVS1210P75111DG	75	100	108~132	190	110	200
MLVS1210P107141DG	107	120	135~165	220	140	200

- V_{RMS} Maximum AC operating voltage the varistor can maintain and not exceed 10μA leakage current
- V_{DC} Maximum DC operating voltage the varistor can maintain and not exceed 10μA leakage current
- V_V-Voltage across the device measured at 1mA DC current. Equivlent to Vb, "Breakdown Voltage".
- Vc Maximum peak voltage across the varistor measured at 8/20us waveform and 2.5A pulse current
- Cp Device capacitance measured with zero volt bias 1Vrms.
- i_{max} Maximum peak current which may be applied with 8/20us waveform without device failure

TITLE: MLVS1210 PDG Series Engineering **Specification**

DOCUMENT NO. ENS000134890

SPEC REV.: A0 Page 3 of 7

www.inpaq.com.tw; www.inpaqgp.com

I-FM-04-40



5. General electrical specifications

5.1. General technical data

Operating temperature	-40 +125°C		
Storage temperature (on board)	-40 +125°C		
Response time	<1 ns		
Solderability	245±5°C, 5 +0/-0.5sec		
Solder leach resistance	260±5°C,10 ±1sec		

5.2. Taping Package Storage Condition

Storage Time: 12 months max. Storage Temperature: 5 to 40°C Relative Humidity: 65% max.

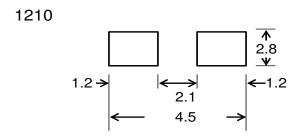
6. Precautions for Handling

6.1. Solder cream in reflow soldering

Refer to the recommendable land pattern as printing mask pattern for solder cream.

(1) Print solder in a thickness of 150 to 200 μ m

Dimensions: millimeters (inches)



6.2. Precaution for handling of substrate

Do not exceed to bend the board after soldering this product extremely. (Reference examples)

- Mounting place must be as far as possible from the position, which is close to the break line of board, or on the line of large holes of board.
- Do not bend extremely the board, in mounting another component.

 If necessary, use back-up pin (support pin) to prevent from bending extremely.
- Do not break the board by hand. We recommend using the machine or the jig to break it.

TITLE : MLVS1210 PDG Series Engineering DOCUMENT NO. Specification SPEC REV.: A0 Page 4 of 7 ENS000134890

<u>www.inpaq.com.tw</u> ; <u>www.inpaqgp.com</u> I-FM-04-40



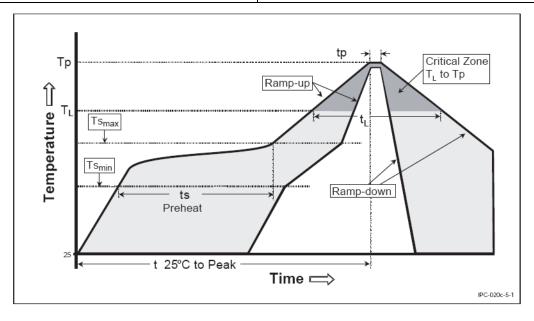
6.3. Precaution for soldering

Note that rapid heating, rapid cooling or local heating will easily damage the component.

Do not give heat shock over 100°C in the process of soldering. We recommend taking preheating and gradual cooling.

6.4. Recommendable reflow soldering

Profile Feature	Pb-Free Assembly	
Average Ramp-Up Rate	3°C/second max.	
(Tsmax to Tp)		
Preheat		
– Temperature Min (Tsmin)	150°C	
– Temperature Max (Tsmax)	200°C	
Time (tsmin to tsmax)	60-180 seconds	
Time maintained above:		
- Temperature (TL)	217°C	
– Time (tL)	60-150 seconds	
Peak/Classification Temperature (Tp)	260°C	
Time within 5 °C of actual Peak	20.40 seconds	
Temperature (tp)	20-40 seconds	
Ramp-Down Rate	6°C/second max.	
Time 25 °C to Peak Temperature	8 minutes max.	



^{*}According to J-STD-020C

В

TITLE: MLVS1210 PDG Series Engineering DOCUMENT NO. Specification DOCUMENT NO. ENS000134890 SPEC REV.: A0 Page 5 of 7

I-FM-04-40



6.5. Solder gun procedure

Note the follows, in case of using solder gun for replacement.

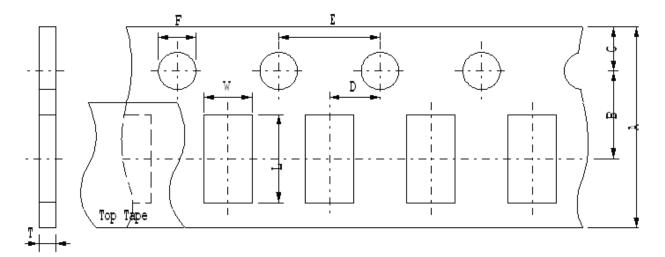
- (1) Use solder tip temperature must be less than 350°C for the period within 3 seconds by using soldering gun under 30W.
- (2) Soldering gun tip shall not touch component directly.

6.6. Soldering volume

Apply proper volume of solder paste, too much may cause crack of component body.

7. Taping Package and Label Marking

7.1. Carrier tape dimensions



Α	В	С	D	Е	F	L	Т	W
8.00±	3.50±	1.75±	2.00±	4.00±	1.50±	3.63±	1.50±	2.84±
0.30	0.05	0.10	0.05	0.10	0.10	0.10	0.10	0.10

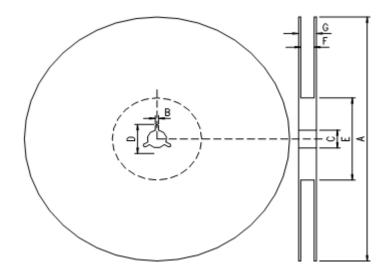
Unit:mm

TITLE: MLVS1210 PDG Series Engineering DOCUMENT NO. Specification DOCUMENT NO. ENS000134890 SPEC REV.: A0 Page 6 of 7

www.inpaq.com.tw; www.inpaqgp.com I-FM-04-40



7.2. Taping reel dimensions



	UNIT: r
Α	178.0±2.
В	2.0±0.5
С	13.0±0.5
D	21.0±0.8
Е	62.0±1.5
F	9.0±0.5
G	13.0±1.0

7.3. Taping specifications

There shall be the portion having no product in both the head and the end of taping, and there shall be the cover tape in the head of taping.

7.4. Label Marking

The label specified as follows shall be put on the side of reel.

- (1) Part No.
- (2) Quantity
- (3) Lot No.

Part No. And Quantity shall be marked on outer packaging.

7.5. Quantity of products in the taping package

- (1) Standard quantity: 2,000pcs/Reel
- (2) Shipping quantity is a multiple of standard quantity.